



#### Product Summary

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C
20V	72mΩ @ $V_{GS}$ = 4.5V	3.4A
200	110mΩ @ V <sub>GS</sub> = 2.5V	2.7A

## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(on)})$  and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Battery Charging
- Power Management Functions
- DC-DC Converters
- Portable Power Adaptors

# Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD protected gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
  Solderable per MIL-STD-202, Method 208 3
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (Approximate)





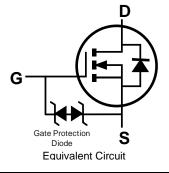
Top View

SOT23



Top View

Pin Configuration



## Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2046U-7	SOT23	3,000/Tape & Reel
DMN2046U-13	SOT23	10,000/Tape & Reel

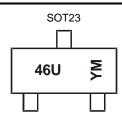
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

#### **Marking Information**



46U = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: B = 2014) M = Month (ex: 9 = September)

Date Code K	ley
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Year	2014	2	2015	2016		2017	2018		2019	2020		2021
Code	В		С	D		E	F		G	Н		
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

#### N-CHANNEL ENHANCEMENT MODE MOSFET



## **Maximum Ratings** ( $@T_A = +25^{\circ}C$ unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage	V <sub>DSS</sub>	20	V		
Gate-Source Voltage			V <sub>GSS</sub>	±12	V
Continuous Drain Current (Note 6) $V_{GS} = 10V$ State $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$			3.4 2.7	А	
Pulsed Drain Current (Pulse width ≤10µS, Duty 0	I <sub>DM</sub>	18	А		

#### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	0.76	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	166	°C/W
Power Dissipation (Note 6)	PD	1.26	W
Thermal Resistance, Junction to Ambient (Note 6)	R <sub>0JA</sub>	100	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

#### Electrical Characteristics @TA = +25°C unless otherwise specified

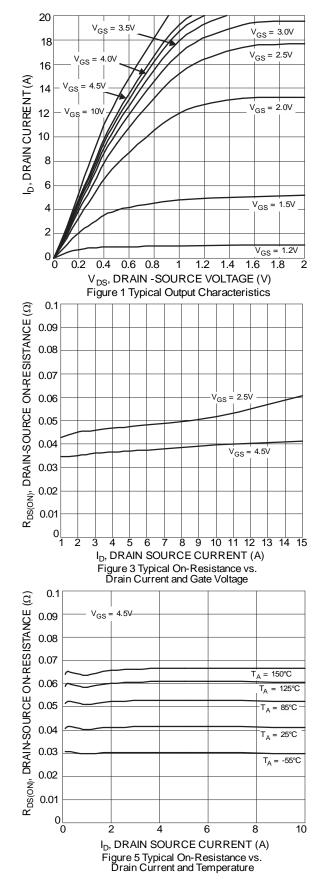
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	<b>BV</b> <sub>DSS</sub>	20	-	-	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current TJ = +25°C	IDSS	-	-	1.0	μA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	-	-	±10	μA	$V_{GS} = \pm 10V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.4	-	1.4	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance	Deserver			72	mΩ	$V_{GS} = 4.5V, I_D = 3.6A$
Static Drain-Source On-Resistance	R <sub>DS</sub> (ON)	-	-	110	11122	V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 3.1A
Diode Forward Voltage	V <sub>SD</sub>	-	-	1.2	V	$V_{GS} = 0V, I_{S} = 0.94A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C <sub>iss</sub>	-	292	-	pF	
Output Capacitance	Coss	-	36	-	pF	$V_{DS} = 10V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	Crss	-	32	-	pF	1 = 1.00012
Gate Resistance	Rg	-	63	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge	Qg	-	3.8	-	nC	
Gate-Source Charge	Q <sub>gs</sub>	-	0.5	-	nC	−V <sub>GS</sub> = 4.5V, V <sub>DS</sub> = 10V, I <sub>D</sub> = −5.1A
Gate-Drain Charge	Q <sub>gd</sub>	-	0.8	-	nC	3.1A
Turn-On Delay Time	t <sub>D(on)</sub>	-	6.7	-	ns	
Turn-On Rise Time	tr	-	25.1	-	ns	$V_{DD} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t <sub>D(off)</sub>	-	69.1	-	ns	$R_L = 2.4\Omega, R_G = 6\Omega$
Turn-Off Fall Time	t <sub>f</sub>	-	34.1	-	ns	]
Reverse Recovery Time	trr	-	18.2	-	ns	I <sub>F</sub> = 4.1A, di/dt = 100A/µs
Reverse Recovery Charge	Qrr	-	3.6	-	nC	I <sub>F</sub> = 4.1A, di/dt = 100A/µs

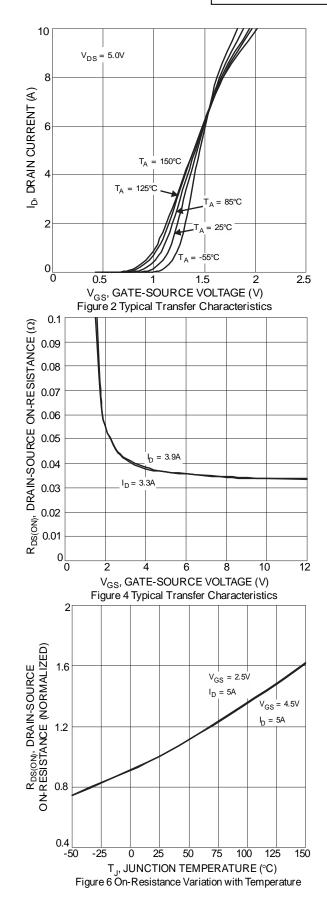
Notes:

Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to production testing.

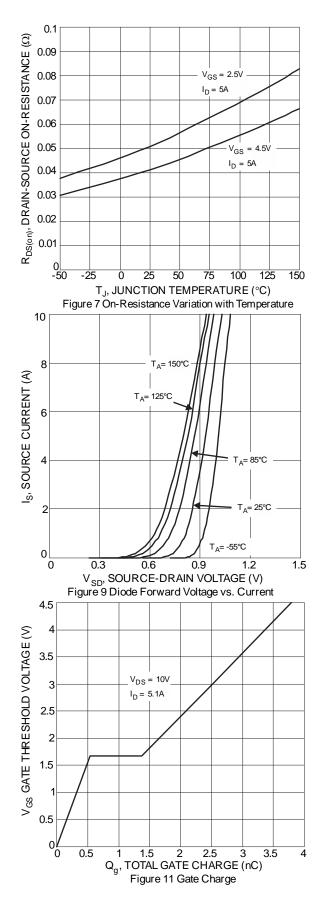


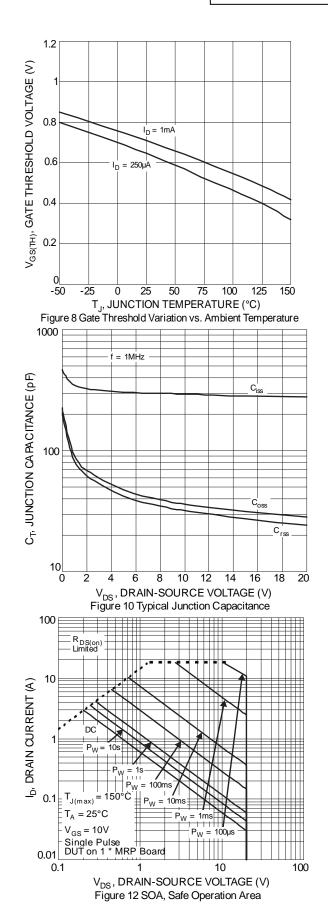
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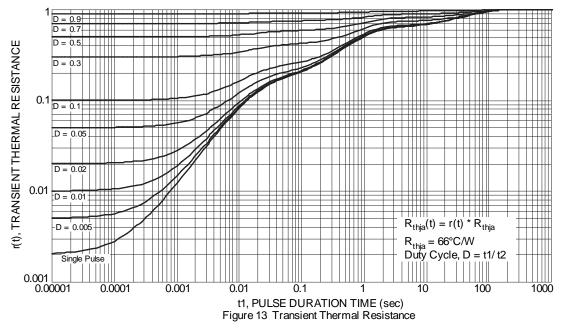






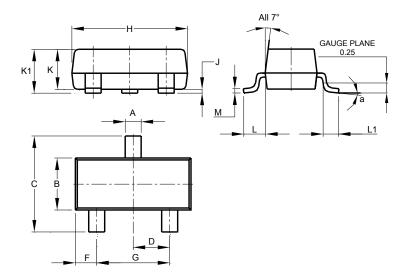






#### **Package Outline Dimensions**

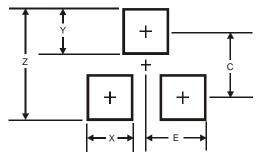
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	SOT23							
Dim	Min	Max	Тур					
Α	0.37	0.51	0.40					
В	1.20	1.40	1.30					
С	2.30	2.50	2.40					
D	0.89	1.03	0.915					
F	0.45	0.60	0.535					
G	1.78	2.05	1.83					
Н	2.80	3.00	2.90					
J	0.013	0.10	0.05					
К	0.890	1.00	0.975					
K1	0.903	1.10	1.025					
L	0.45	0.61	0.55					
L1	0.25	0.55	0.40					
М	0.085	0.150	0.110					
а	8°							
All	All Dimensions in mm							

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Y	0.9
С	2.0
E	1.35



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